

Dual N-Channel 20-V (D-S) MOSFET

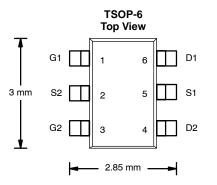
PRODUCT SUMMARY					
V _{DS} (V)	r _{DS(on)} (Ω)	I _D (A)			
20	0.125 @ V _{GS} = 4.5 V	2.4			
	0.200 @ V _{GS} = 2.5 V	1.8			

FEATURES

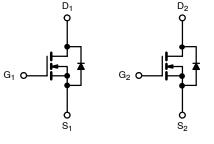




Pb-free Available



Ordering Information: Si3900DV-T1 Si3900DV-T1—E3 (Lead (Pb)-Free)



N-Channel MOSFET N

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	(T _A = 25°C U	NLESS OTHE	ERWISE NO	TED)		
Parameter		Symbol	5 sec	Steady State	Unit	
Drain-Source Voltage		V _{DS}	20			
Gate-Source Voltage		V _{GS}	±12		V	
	$T_A = 25^{\circ}C$	– I _D	2.4	2.0		
Continuous Drain Current $(T_J = 150^{\circ}C)^a$	$T_A = 85^{\circ}C$		1.7	1.4		
Pulsed Drain Current (10 µs Pulse Width)		I _{DM}		A		
Continuous Source Current (Diode Conduction) ^a		۱ _S	1.05	0.75		
	$T_A = 25^{\circ}C$		1.15	0.83		
Maximum Power Dissipation ^a	T _A = 85°C	– P _D	0.59	0.53	w	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150		°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	$t \le 5 \text{ sec}$	R _{thJA}	93	110		
Maximum Junction-to-Ambient ^a	Steady State		130	150	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	75	90		

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

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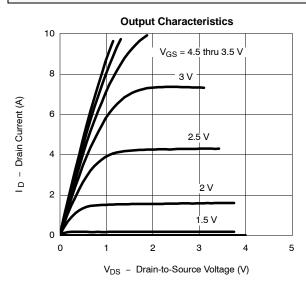


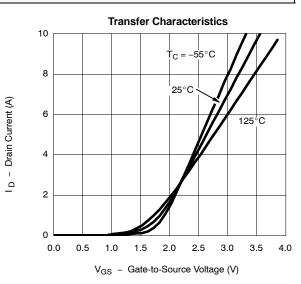
SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)								
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit		
Static						•		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.6		1.5	V		
Gate-Body Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = \pm 12 V			±100	nA		
Zero Gate Voltage Drain Current		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA		
	IDSS	V_{DS} = 20 V, V_{GS} = 0 V, T_{J} = 85 $^{\circ}C$			10			
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5$ V, V_{GS} = 4.5 V	5			A		
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 2.4 \text{ A}$ $V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 1.0 \text{ A}$		0.100	0.125	Ω		
Drain-Source On-State Resistance ^a	rDS(on)			0.160	0.200			
Forward Transconductancea	9fs	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 2.4 \text{ A}$		5		S		
Diode Forward Voltage ^a	V _{SD}	$I_{S} = 1.05 \text{ A}, V_{GS} = 0 \text{ V}$		0.79	1.10	V		
Dynamic ^b	<u>.</u>		·					
Total Gate Charge	Qg			2.1	4.0	nC		
Gate-Source Charge	Q _{gs}	V_{DS} = 10 V, $~V_{GS}$ = $~4.5$ V, I_{D} = 2.4 A		0.3				
Gate-Drain Charge	Q _{gd}			0.4		1		
Turn-On Delay Time	t _{d(on)}			10	17	ns		
Rise Time	t _r	V _{DD} = 10 V, R _I = 10 Ω		30	50			
Turn-Off Delay Time	t _{d(off)}	$\begin{array}{l} V_{\text{DD}} = \text{10 V, } R_{\text{L}} = \text{10 } \Omega \\ I_{\text{D}} \cong \text{1 A, } V_{\text{GEN}} = \text{4.5 V, } R_{\text{G}} = \text{6} \Omega \end{array}$		14	25			
Fall Time	t _f			6	12	1		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 3.0 A, di/dt = 100 A/μs		30	50			

 $\begin{array}{ll} \mbox{Notes} \\ \mbox{a.} & \mbox{Pulse test; pulse width} \leq 300 \ \mu \mbox{s, duty cycle} \leq 2\%. \\ \mbox{b.} & \mbox{Guaranteed by design, not subject to production testing.} \end{array}$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

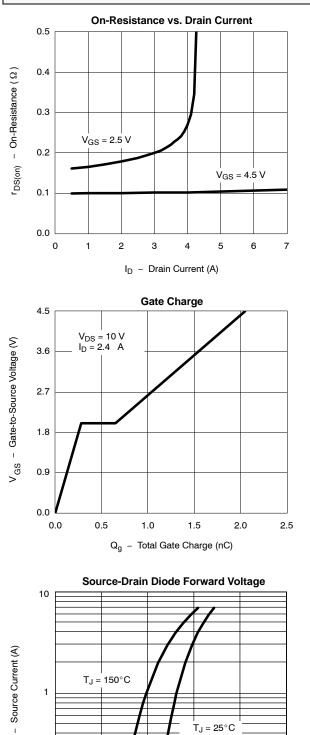






Si3900DV **Vishay Siliconix**

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

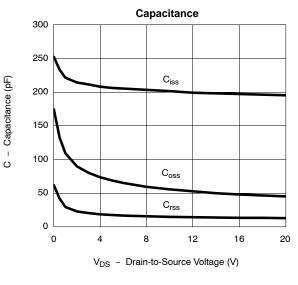


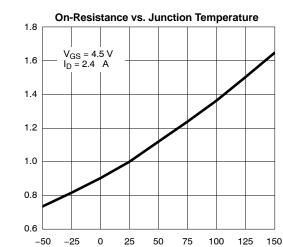
T_J = 25°C

1.2

1.5

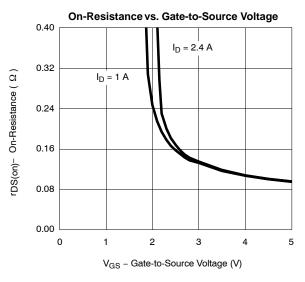
0.9





r_{DS(on)} – On-Resiistance (Normalized)





S

0.1

0.00

0.3

0.6

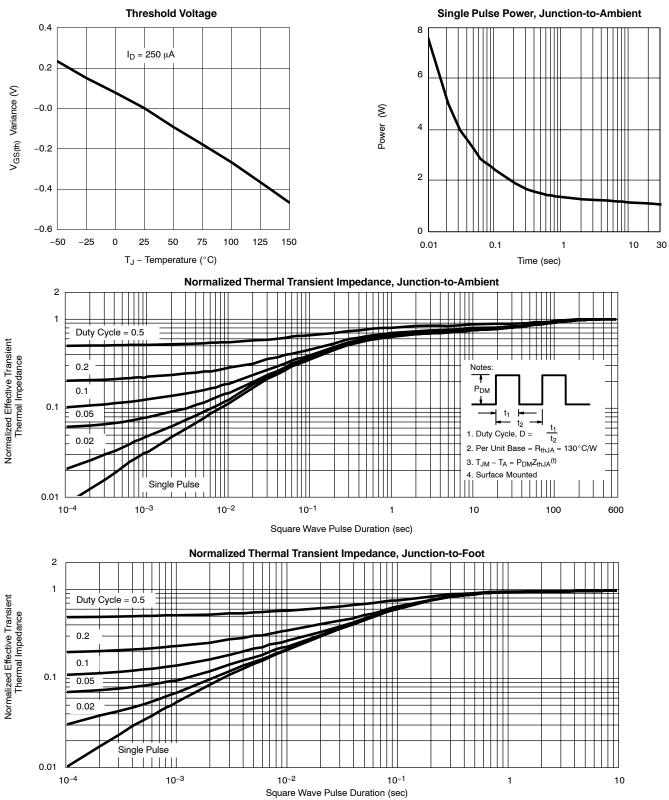
V_{SD} - Source-to-Drain Voltage (V)

Si3900DV

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TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?71178.



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